

Conference Agenda

Day 1 | Wednesday, May 13, 2026 *(times subject to change)*

Register or learn more [here](#)

| 8:15 AM | Registration, Coffee & Breakfast in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | |
|-----------|--|-------------------------------|--|-------------------------------|--|--------------------------------|----------------------------------|
| | Advanced Seminar Room: GOLD | Advanced Seminar Room: COPPER | Advanced Seminar Room: SILVER | Advanced Seminar Room: BRONZE | Advanced Seminar Room: AMETHYST | Advanced Seminar Room: EMERALD | Advanced Seminar Room: CORAL |
| 9:15 AM* | Structures | Multibody System Dynamics | Fluids | Multiphysics | Electromagnetics | Modeling & Simulation | Manufacturing Process Simulation |
| 10:45 AM | Morning Break in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | |
| | Advanced Seminar Room: GOLD | Advanced Seminar Room: COPPER | Advanced Seminar Room: SILVER | Advanced Seminar Room: BRONZE | Advanced Seminar Room: AMETHYST | Advanced Seminar Room: EMERALD | Advanced Seminar Room: CORAL |
| 11:15 AM* | Structures | Multibody System Dynamics | Fluids | Multiphysics | Electromagnetics | Modeling & Simulation | Manufacturing Process Simulation |
| 12:45 PM | Plated Lunch, Sponsor Exhibit Area & Playground Open – Sponsored by VIAS3D | | | | | | |
| 1:45 PM | Welcome & Opening Remarks, Mark Bohm, Dassault Systèmes | | | | | | |
| 1:55 PM | SIMULIA Brand Insights 2026, Michelle Ash, SIMULIA CEO | | | | | | |
| 2:15 PM | Keynote Presentation: Learning the Physical World: Neural Models for Simulation, and Design, Hadi Meidani, University of Illinois at Urbana-Champaign | | | | | | |
| 2:45 PM | Roundtable Discussion: Partnerships to Build Industrial AI Platforms for Virtual Twins, Dassault Systèmes, Hadi Meidani, + Additional Special Guests | | | | | | |
| 3:30 PM | Afternoon Break in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | |
| | SIMULIA Update I – GOLD | SIMULIA Update II – COPPER | SIMULIA Update III – SILVER | SIMULIA Update IV – BRONZE | SIMULIA Update V – AMETHYST | SIMULIA Update VI – EMERALD | SIMULIA Update VII – Coral |
| 4:00 PM | Structures | Multibody System Dynamics | Fluids Portfolio R&D Update (45 minutes) R&D Update on AI/ML for Fluids (45 minutes) <i>Nicolas Fougere, Dassault Systèmes</i> | Session I: Vibro-Acoustics | Electromagnetics Technology Updates 2026 <i>Sebastian Kizewski, Scott Piper & Frank Scharf, Dassault Systèmes</i> | Modeling & Simulation | Session I: Multiphysics |
| 4:30 PM | | TBA | | TBA | | | TBA |
| 5:00 PM | | TBA | | TBA | | | TBA |
| 5:30 PM | Reception in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | |

*See Page 4 for Advanced Seminar Descriptions

Conference Agenda

Day 2 | Thursday, May 14, 2026 *(times subject to change)*

Register or learn more [here](#)

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|---|---|--|---|---|--|--|---|--|
| 8:15 AM | Registration, Coffee & Breakfast in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | | |
| 9:15 AM | Welcome & Opening Remarks, Mark Bohm & Peer-Philipp Krambeer, Dassault Systèmes | | | | | | | |
| 9:30 AM | Modeling & Simulation (+AI) – Enabling Transformation from Sequential to Concurrent Engineering, Ramji Kamakoti, Dassault Systèmes | | | | | | | |
| 10:00 AM | Keynote Presentation: Why 3DEXPERIENCE Has Become a Transformative Experience for the Ford Chassis CAE Engineering Team, Satyendra Savanur, Ford Motor Co. | | | | | | | |
| 10:30 AM | Morning Break in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | | |
| 11:00 AM | SIMULIA Presentation: TBA | | | | | | | |
| 11:30 AM | Keynote Presentation: Advancing Generative Design and Optimization with Modeling & Simulation, Jason Action, Lockheed Martin | | | | | | | |
| 12:00 PM | SIMULIA Champions Welcome | | | | | | | |
| 12:15 PM | Group Photo, Plated Lunch, Sponsor Exhibit Area & Playground Open – Sponsored by VIAS3D | | | | | | | |
| THANK YOU TO OUR GOLD & SILVER SPONSORS! | | | | | | | | |
| | Track 1 – GOLD Sponsor Session | Track 2 – SILVER Sponsor Session | Track 3 – COPPER Sponsor Session | Track 4 – BRONZE Sponsor Session | Track 5 – AMETHYST Sponsor Session | Track 6 – EMERALD Sponsor Session | | |
| 1:30 PM | GoEngineer | Enabling Agile Design Reviews for Abaqus users: Transitioning from Static Reports to Interactive 3D Slides / Workflows <i>Prasad Mandava, VCollab</i> | Multiphysics of Oxidation and Fatigue in Elastomer Automotive Applications <i>William Mars, Endurica LLC</i> | Introducing Coreform IGA for Abaqus - Empowering Meshing-free Workflows for Abaqus Simulations <i>Michael Scott, Coreform</i> | Load Reconstruction with Wolf Star Technologies' True-Load <i>Tim Hunter, Wolf Star</i> | TotalCAE HPC Technology Choices for Accelerating the SIMULIA Portfolio <i>Rod Mach, TotalCAE</i> | | |
| 1:50 PM | Become a Simulation Olympian: The Analyst's Journey on the 3DEXPERIENCE Platform <i>Benjamin Beckelynych, Technia</i> | Same Goals, Different Rules: FEA Automation Then and Now <i>Tom Feister, TriMech Solutions</i> | Automated Polymer Material Characterization for Abaqus Using VALIMAT®- AUTOFIT Workflow <i>Arjun Balagopal Menon, 4aEngineering GmbH</i> | TATA Technologies | VIAS3D | TBA | | |
| Customer Technical Breakout Sessions | | | | | | | | |
| | Track 1 – GOLD Structure I | Track 2 – SILVER Structures II | Track 3 – COPPER Structures III | Track 4 – BRONZE Electromagnetics | Track 5 – AMETHYST MODSIM | Track 6 – EMERALD Multidiscipline | Track 7 – CORAL Fluids | Track 8 – PEARL Vibro-Acoustics |
| 2:10 PM | TBA | From Virtual Validation to Reliable Design: CAE Across Caterpillar Machines <i>Ashraf Idkaidek, Caterpillar</i> | Utilizing Rubber Coated Metal (RCM) Gaskets to Seal Openings with a Thin Steel Cover <i>Brian Engel, Dauch Corp. (Formally AAM)</i> | Advanced Electronic Packaging System Level Modeling: PCB Voxelization and Submodeling <i>Shams Arifeen & Aiman Shibli, Google</i> | TBA | Predictive Simulation and Virtual Twin Framework for Material and Design Optimization in Comfort-Focused Products <i>Arindam Chakraborty, VIAS3D, on behalf of Purple Innovations</i> | Power insight VR Enabling Real Time Collaboration for Flow Field Understanding, <i>Fernando Saito, General Motors</i> | Flight Test Reduction via Vibroacoustic Analysis <i>Gary Simpson, Lockheed Martin</i> |
| 2:40 PM | Prismatic Cell Enclosure Analysis Using Ductile Damage Model <i>Arturo Sanchez, General Motors</i> | TBA | From Microstructure to Bulk Response: Multiscale Modeling of Fiber-Reinforced Soft Materials in Abaqus <i>MD Saiful Islam, University of Louisiana-Lafayette</i> | Efficient Gap Modeling in CST Studio Suite for Early Prediction of EMC Failures in Automotive Shielded Interconnects <i>Safal Sharma & Abbas Alwishah, Molex</i> | Optimization Process Applied to Agricultural Tires <i>Victor Messias, Titan Tire & Thomas Schlitt, GoEngineer</i> | MOBI-LAB: A Multibody-Driven Load Intelligence Framework for Vehicle Performance <i>Paul Lucas, Daimler Truck North America</i> | High-Fidelity Computational Approach to Study sUAS Aerodynamic Degradation in Rime Ice Conditions <i>Edwin Daniel, NIAR - Wichita State University</i> | TBA |
| 3:10 PM | Afternoon Break in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | | |

Conference Agenda Day 2 Continued (times subject to change)

Register or learn more [here](#)

| | Track 1 – GOLD Structure I | Track 2 – SILVER Structures II | Track 3 – COPPER Structures III | Track 4 – BRONZE Electromagnetics | Track 5 – AMETHYST MODSIM | Track 6 – EMERALD MODSIM II | Track 7 – CORAL Fluids | Track 7 – PEARL Vibro-Acoustics |
|---------|---|--|--|--|--|--|--|------------------------------------|
| 3:40 PM | Progressive Failure Simulation of Both Polymer- and Ceramic-Matrix Composites Performed Using Abaqus <i>Dr. Jim Roach, RTX – Pratt & Whitney</i> | From Abaqus Simulation to Real-Time Structural Integrity Using Physics-Informed AI <i>Benedikt Engel, MatAlytics Ltd,</i> | Rotordynamics Design Analysis of a High-Speed Composite Flywheel: Key Challenges & Solutions <i>Joshua Gorfain, Quartus Engineering</i> | Investigation of Electromagnetic Emissions from Automotive DC-DC Converters <i>Matthew Gee, Robert Bosch</i> | Ultra-Optimized Packaging Design <i>Brad Philip, Amcor Rigid Packaging</i> | Flow Driven Generative Design and Parametric Optimization Case Studies <i>Prashanth (Pat) Pai, Ford Motor Co.</i> | Computational Framework for Designing and Testing Novel Open Rotors Propeller <i>Barry Lim, Wichita State University - NIAR</i> | TBA |
| 4:10 PM | Motor Laminate Stack Interlocking & Dismantle Simulation <i>Marcus Chen, General Motors</i> | Automating Results Extraction for Families of Products <i>Henry Hojnacki, Engineering Strategies</i> | High Cycle Fatigue Evaluation of a Marine Outboard Cylinder Head Under Combined Assembly, Thermal, and Vibratory Loading <i>Ameer Ambavaram, Mercury Marine</i> | An Analytic Approach for the Noise and Vibration Optimization of an Electric Motor <i>Babak Sakhaei, Dana TM4 Inc.</i> | Non-Pneumatic Tire Design and Validation <i>Thomas Feister, TriMech Solutions on behalf of A3T LLC</i> | TBA | Introduction, and Execution of Advance Common Model at General Motors for PowerFLOW Simulations <i>Antonino Destasi & Brian Schroll, General Motors</i> | TBA |
| 4:40 PM | Numerical Assessment of High- and Low-Cycle Bending Fatigue Failure in ENP-Coated Carburized Shafts <i>Anoop Vasu, Dauch Corp. (Formerly AAM)</i> | Nonlocal Drucker-Prager Plasticity: A VUMAT Implementation, Verification, and Application <i>Timmy Ngo, Purdue University</i> | TBA | Compact High-Performance Circularly Polarized Dish Feed for 1296 MHz <i>Bill Siino, Curious Communications & Clint Patton, GoEngineer</i> | Topology Optimization for Lightweight Aerospace Structures in 3DEXPERIENCE <i>Andy Shahbazian, Iliad Innovations – supporting U.S. Air Force–aligned programs</i> | Medical Device Product Development – Ensuring Success amidst Uncertainty <i>Kyle Johnson, NeoCoil & Chris Schaefer, GSC</i> | TBA | TBA |
| 5:10 PM | Evening Reception in Sponsor Exhibit Area and 3DEXPERIENCE Playground | | | | | | | |

Advanced Seminar Descriptions

Register or learn more [here](#)

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|---|--|
| Structures | <ul style="list-style-type: none"> • Session 1: Practical Nonlinear Finite Element Analysis with Abaqus • Session 2: A General Review of Fatigue Assessments, Including the Recent Trends of AI/ML Adoption on Fatigue |
| Multibody System Dynamics | <p>Agenda to include:</p> <ul style="list-style-type: none"> • Multibody and Motion Technology: Current State and Motion Roles on the 3DEXPERIENCE Platform • SIMPACT Realtime and ADAS applications |
| Fluids | <p>Agenda to include:</p> <ul style="list-style-type: none"> • New Native Thermal Solver in PowerFLOW • Advances in Fluids AI/ML • Virtual Porous Media Lab for Semiconductor Manufacturing • Updates on GPU Compute |
| Multiphysics | <ul style="list-style-type: none"> • Session 1: SIMULIA Multiphysics Simulation Framework • Session 2: Electromechanical Systems Modeling • Session 3: Fluid Structure Interaction (FSI) in 3DEXPERIENCE Platform • Session 4: Battery Modeling Using Abaqus |
| Electromagnetics | <ul style="list-style-type: none"> • Session 1: Electromagnetic Simulations for the T&M Industry: An Overview • Session 2: Electromagnetics Focus Application: EMC/EMI • Session 3: Electromagnetics Focus Application: Motor Design and Acoustic Noise Control • Session 4: Electromagnetics Focus Application: Electro-Thermal Co-Simulation |
| Modeling & Simulation | <ul style="list-style-type: none"> • Session 1: MODSIM R&D Updates • Session 2: MODSIM Foundations • Session 3: MODSIM Advanced |
| Manufacturing Process Simulation | <ul style="list-style-type: none"> • Session 1: SIMULIA Manufacturing Process Simulation Overview • Session 2: Welding Simulation Using Abaqus • Session 3: Composite Curing Simulation • Session 4: Semiconductor Manufacturing Process |